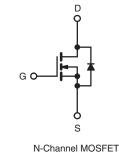


Vishay Siliconix

Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	400				
R _{DS(on)} (Ω)	$V_{GS} = 10 V$	0.30			
Q _g (Max.) (nC)	76				
Q _{gs} (nC)	20				
Q _{gd} (nC)	37				
Configuration	Single				





FEATURES

- Ultra Low Gate Charge
- Reduced Gate Drive Requirement
- Enhanced 30V V_{GS} Rating
- Reduced C_{iss}, C_{oss}, C_{rss}
- Isolated Central Mounting Hole
- Dynamic dV/dt Rated
- Repetitive Avalanche Rated
- Compliant to RoHS Directive 2002/95/EC

DESCRIPTION

This new series of low charge Power MOSFETs achieve significantly lower gate charge over conventional MOSFETs. Utilizing advanced MOSFETs technology the device improvements allow for reduced gate drive requirements, faster switching speeds and increased total system savings. These device improvements combined with the proven ruggedness and reliability of MOSFETs offer the designer a new standard in power transistors for switching applications.

TO-247AC The package is preferred for commercial-industrial applications where higher power levels preclude the use of TO-220AB devices. The TO-247AC is similar but superior to the earlier TO-218 package because of its isolated mounting hole.

ORDERING INFORMATION	
Package	TO-247AC
Lead (Pb)-free	IRFP350LCPbF
	SiHFP350LC-E3
SnPb	IRFP350LC
	SiHFP350LC

ABSOLUTE MAXIMUM RATINGS ($T_{\mbox{\scriptsize C}}$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	400	v	
Gate-Source Voltage			V _{GS}	± 30		
Continuous Drain Current	V at 10 V	$T_C = 25 \degree C$ $T_C = 100 \degree C$	1-	16		
	V _{GS} at 10 V	$T_{C} = 100 ^{\circ}C$	ID	9.9	А	
Pulsed Drain Current ^a			I _{DM}	64		
Linear Derating Factor				1.5	W/°C	
Single Pulse Avalanche Energy ^b			E _{AS}	390	mJ	
Repetitive Avalanche Current ^a			I _{AR}	16	А	
Repetitive Avalanche Energy ^a			E _{AR}	19	mJ	
Maximum Power Dissipation	T _C =	25 °C	PD	190	W	
Peak Diode Recovery dV/dtc			dV/dt	4.0	V/ns	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	- 55 to + 150	*0	
Soldering Recommendations (Peak Temperature)	for	10 s		300 ^d	°C	
Mounting Torque	6-32 or M3 screw			10	lbf ∙ in	
				1.1	N · m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. $V_{DD} = 25 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 2.7 mH, $R_g = 25 \Omega$, $I_{AS} = 16 \text{ A}$ (see fig. 12).

c. $I_{SD} \le 16 \text{ A}$, dl/dt $\le 200 \text{ A}/\mu s$, $V_{DD} \le V_{DS}$, $T_J \le 150 \text{ °C}$.

d. 1.6 mm from case.

* Pb containing terminations are not RoHS compliant, exemptions may apply

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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum Junction-to-Ambient	R _{thJA}	-		40		°C/W			
Case-to-Sink, Flat, Greased Surface	R _{thCS}	0.24							
Maximum Junction-to-Case (Drain)	R _{thJC}	- 0.65							
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$, u	nless otherw	ise noted)						1	
PARAMETER	SYMBOL	TEST (CONDITI	ONS	MIN.	TYP.	MAX.	UNIT	
Static		-							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$) V, I _D = 2	250 μA	400	-	-	V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference to 25 °C, $I_D = 1 \text{ mA}$			-	0.49	-	V/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$			2.0	-	4.0	V	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 V$			-	-	± 100	nA	
Zero Gate Voltage Drain Current	V _{DS} = 400 V, V _G	s = 0 V	-	-	25	ıΔ			
Zero date voltage Drain Carrent	I _{DSS}	V _{DS} = 320 V, V	V_{DS} = 320 V, V_{GS} = 0 V, T_{J} = 125 $^{\circ}\text{C}$		-	-	250	μA	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	l	_D = 9.6 A ^b	-	-	0.30	Ω	
Forward Transconductance	9 _{fs}	$V_{DS} = 50 \text{ V}, \text{ I}_{D} = 9.6 \text{ A}^{b}$			8.1	-	-	S	
Dynamic									
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = 25 V,		-	2200	-	pF		
Output Capacitance	C _{oss}			-	390	-			
Reverse Transfer Capacitance	C _{rss}	f = 1.0 MHz, see fig. 5			-	31		-	
Total Gate Charge	Qg			= 16 A, V _{DS} = 320 V	-	-	76	nC	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$			-	-	20		
Gate-Drain Charge	Q _{gd}		see	fig. 6 and 13 ^b	-	-	37		
Turn-On Delay Time	t _{d(on)}				-	14	-	-	
Rise Time	t _r	$V_{DD} = 200 \text{ V}, \text{ I}_D = 16 \text{ A},$ $R_g = 6.2 \ \Omega, \text{ R}_D = 12 \ \Omega, \text{ see fig. } 10^{\text{b}}$		= 16 A,	-	54	-		
Turn-Off Delay Time	t _{d(off)}			-	33	-	ns		
Fall Time	t _f			-	35	-			
Drain-Source Body Diode Characteristic	s								
Continuous Source-Drain Diode Current	I _S	showing the	MOSFET symbol showing the		-	-	16	•	
Pulsed Diode Forward Current ^a	I _{SM}	integral reverse p - n junction diode		-	-	64	A		
Body Diode Voltage	V _{SD}	$T_J = 25 \text{ °C}, I_S = 16 \text{ A}, V_{GS} = 0 \text{ V}^{b}$		-	-	1.6	V		
Body Diode Reverse Recovery Time	t _{rr}	$T_{\rm J} = 25 \text{ °C, } I_{\rm F} = 16 \text{ A, } dl/dt = 100 \text{ A}/\mu\text{s}^{\rm b}$		-	440	660	ns		
Body Diode Reverse Recovery Charge	Q _{rr}			-	4.1	6.2	μC		
Forward Turn-On Time	t _{on}	Intrinsic turn-	-on is dor	ninated b	$_{\rm by L_S}$ and	L _D)			

Notes

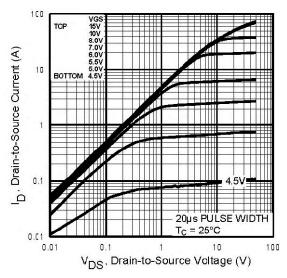
a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11).

b. Pulse width \leq 300 µs; duty cycle \leq 2 %.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

Fig. 1 - Typical Output Characteristics, $T_C = 25$ °C

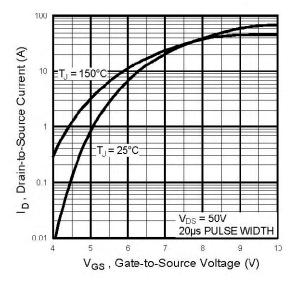


Fig. 3 - Typical Transfer Characteristics

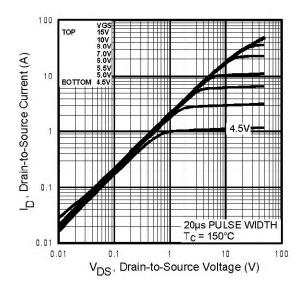


Fig. 2 - Typical Output Characteristics, $T_C = 150 \ ^{\circ}C$

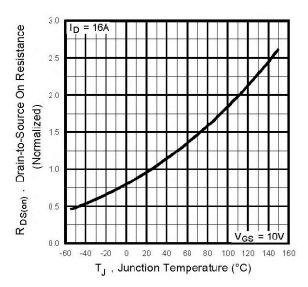


Fig. 4 - Normalized On-Resistance vs. Temperature

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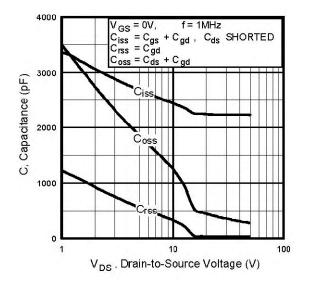


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

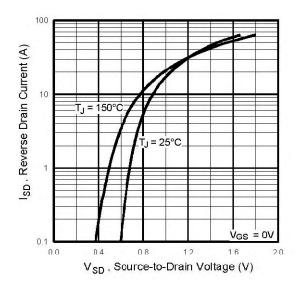


Fig. 7 - Typical Source-Drain Diode Forward Voltage

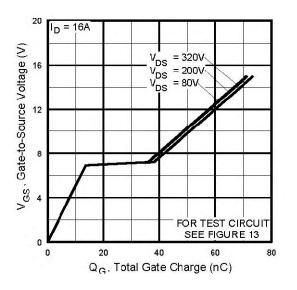


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

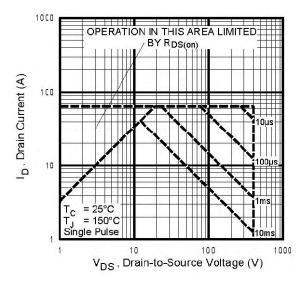


Fig. 8 - Maximum Safe Operating Area

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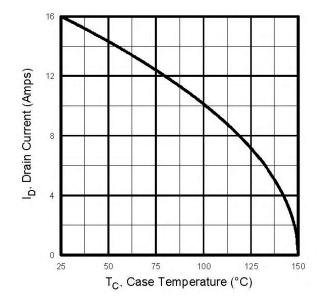


Fig. 9 - Maximum Drain Current vs. Case Temperature

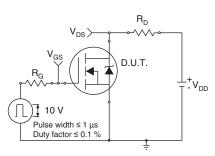


Fig. 10a - Switching Time Test Circuit

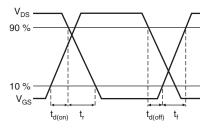


Fig. 10b - Switching Time Waveforms

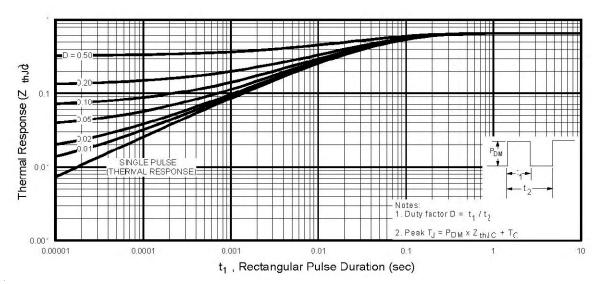


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

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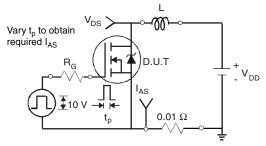


Fig. 12a - Unclamped Inductive Test Circuit

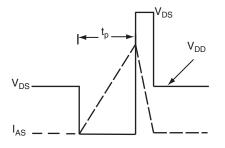


Fig. 12b - Unclamped Inductive Waveforms

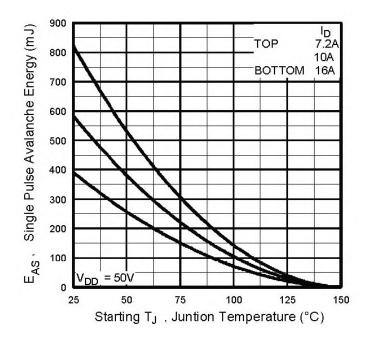


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

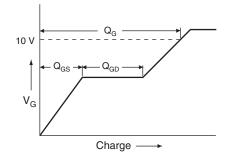


Fig. 13a - Basic Gate Charge Waveform

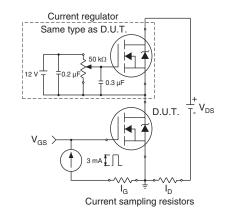
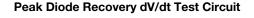


Fig. 13b - Gate Charge Test Circuit

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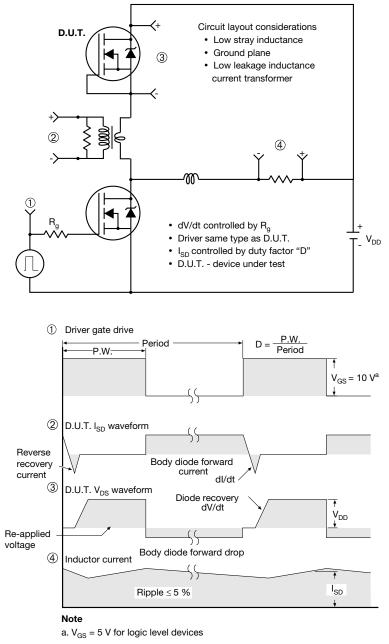


Fig. 14 - For N-Channel

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